

Docket No.: 57454-946

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Hideto HIDAKA, et al.

Serial No.: Divisional of
Appln. Serial No. 09/370,220

Group Art Unit: Not yet assigned

Filed: June 23, 2003

Examiner: Not yet assigned

For: SEMICONDUCTOR DEVICE USING AN SOI SUBSTRATE

INFORMATION DISCLOSURE STATEMENT

Mail Stop Patent Application
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:


In accordance with the provisions of 37 C.F.R. 1.56, 1.97 and 1.98, the attention of the Patent and Trademark Office is hereby directed to the references listed on the attached form PTO-1449. It is respectfully requested that the references be expressly considered during the prosecution of this application, and that the references be made of record therein and appear among the "References Cited" on any patent to issue therefrom.

This Information Disclosure Statement is being filed within three months of the U.S. filing date OR before the mailing date of a first Office Action on the merits. No certification or fee is required.

The references were cited by or submitted to the U.S. Patent and Trademark Office in parent application Serial No. 09/370,220, filed August 9, 1999, which is relied upon for an earlier filing date under 35 USC 120. Thus, copies of these references are not attached. 37 CFR 1.98(d).

Respectfully submitted,

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Date: June 23, 2003

INFORMATION DISCLOSURE CITATION IN AN APPLICATION			ATTY. DOCKET NO. 57454-946		SERIAL NO. (Divisional of Appln. Serial No. 09/370,220)	
(PTO-1449)			APPLICANT Hideto HIDAKA, et al.			
			FILING DATE June 23, 2003		GROUP Not yet assigned	
U.S. PATENT DOCUMENTS						
EXAMINER'S INITIALS	PATENT NO.	DATE	NAME	CLASS	SUBCLASS	FILING DATE
	5,256,899	10/26/93	Rangappan			
	5,798,475	8/25/98	Reynes et al.			
	5,440,161	8/8/95	Iwamatsu et al.			
	4,849,805	7/18/89	Herbert et al.			
	4,602,420	7/29/86	Saito			
	4,903,111	2/20/90	Takemae et al.			
	5,635,744	6/3/97	Hidaka et al.			
	4,899,202	2/6/90	Blake et al.			
	4,946,799	8/7/90	Blake et al.			
	4,965,213	10/23/90	Blake			
	5,125,007	6/23/92	Yamaguchi et al.			
	4,628,590	12/16/86	Udo et al.			
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	5,559,348	9/96	Watanabe et al.			
	5,356,822	10/94	Lin et al.			
	5,017,512	5/91	Takagi			
FOREIGN PATENT DOCUMENTS						
EXAMINER'S INITIALS	PATENT NO.	DATE	COUNTRY	CLASS	SUBCLASS	Translation
						Yes No
OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.)						
EXAMINER				DATE CONSIDERED		

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to Applicant.

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			FILING DATE June 23, 2003		GROUP Not yet assigned	
U.S. PATENT DOCUMENTS						
EXAMINER'S INITIALS	PATENT NO.	DATE	NAME	CLASS	SUBCLASS	FILING DATE
	4,851,894	7/25/89	de Ferron et al.			
	5,223,735	6/29/93	Kinoshita et al.			
	5,212,397	5/18/93	See et al.			
	4,675,982	6/30/87	Noble, Jr. et al.			
	4,413,272	11/1/83	Mochizuki et al.			
	5,252,844	10/12/93	Takagi			
	5,246,870	9/21/93	Merchant			
	3,792,319	2/12/74	Tsang			
	4,590,509	5/20/86	Esser et al.			
	5,025,300	6/18/91	Billig et al.			
FOREIGN PATENT DOCUMENTS						
EXAMINER'S INITIALS	PATENT NO.	DATE	COUNTRY	CLASS	SUBCLASS	Translation
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